

**40V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

**Product Summary**

$V_{(BR)DSS}$	$R_{DS(on)}$	$I_D$ $T_A = 25^\circ C$
40V	27m $\Omega$ @ $V_{GS} = 10V$	7.1A
	47m $\Omega$ @ $V_{GS} = 4.5V$	5.4A

**Features and Benefits**

- Low on-resistance
- Fast switching speed
- “Green” component and RoHS compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability

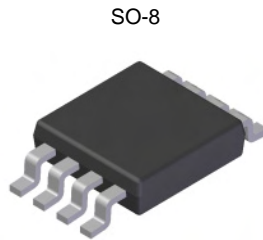
**Description and Applications**

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

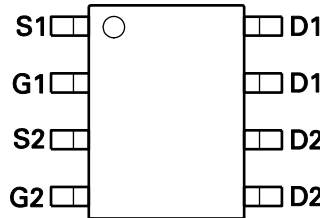
- Motor control
- Backlighting
- DC-DC Converters
- Power management functions

**Mechanical Data**

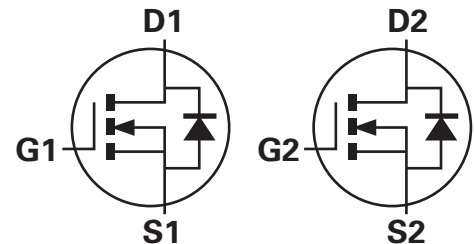
- Case: SO-8
- Case Material: Molded Plastic, “Green” Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See diagram below
- Terminals: Finish - Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Weight: 0.074 grams (approximate)



Top View



Top View



Equivalent Circuit

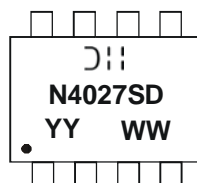
**Ordering Information** (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN4027SSD-13	N4027SD	13	12	2,500

Note: 1. Diodes, Inc. defines “Green” products as those which are RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.’s “Green” Policy can be found on our website. For packaging details, go to our website.

**Marking Information**

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$\text{D}||$  = Manufacturer's Marking  
 N4027SD = Product Type Marking Code  
 YYWW = Date Code Marking  
 YY = Year (ex: 09 = 2009)  
 WW = Week (01-53)

**Maximum Ratings** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

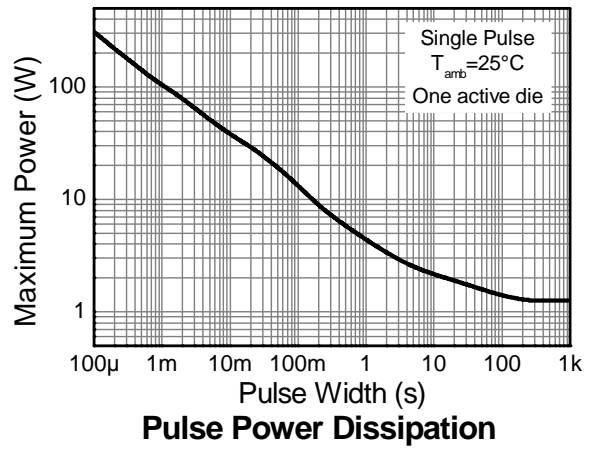
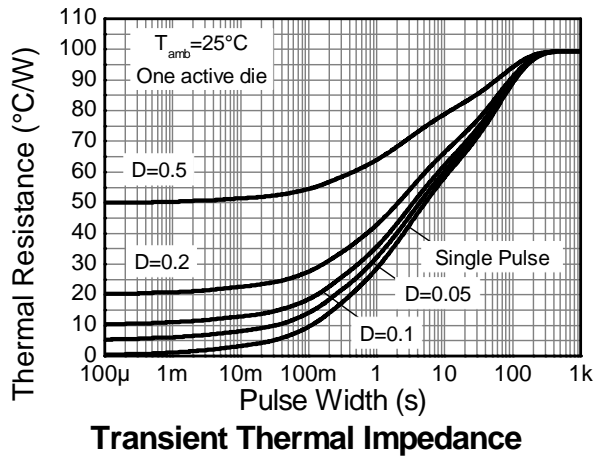
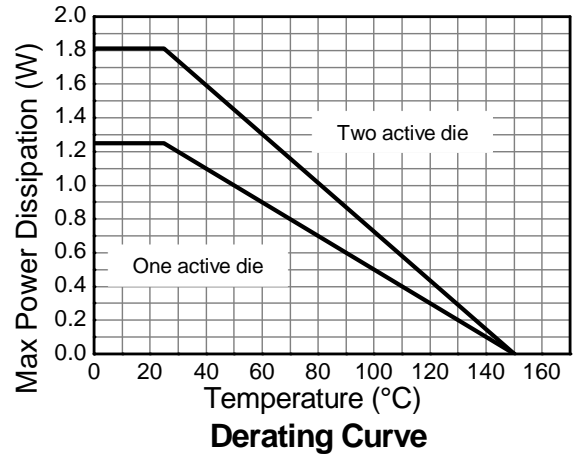
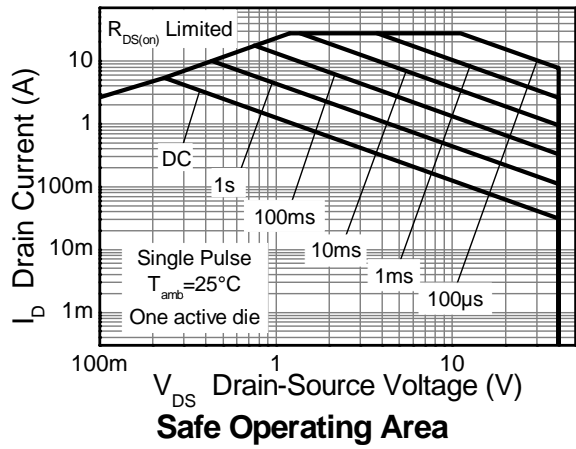
Characteristic		Symbol	Value	Unit	
Drain-Source voltage		$V_{DSS}$	40	V	
Gate-Source voltage		$V_{GS}$	$\pm 20$	V	
Continuous Drain current	$V_{GS} = 10\text{V}$	(Note 2)			
		(Note 4)	7.1	A	
		$T_A = 70^\circ\text{C}$ (Note 4)	5.7		
		(Note 3)	5.4		
Pulsed Drain current	$V_{GS} = 10\text{V}$	(Note 5)	$I_{DM}$		28.0
Continuous Source current (Body diode)		(Note 4)	$I_S$	3.3	A
Pulsed Source current (Body diode)		(Note 5)	$I_{SM}$	28.0	A

**Thermal Characteristics** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic		Symbol	Value	Unit
Power dissipation Linear derating factor	(Notes 3 & 6)	$P_D$	1.25	W $\text{mW}/^\circ\text{C}$
	(Notes 3 & 7)		10.0	
	(Notes 4 & 6)		1.8	
			14.3	
Thermal Resistance, Junction to Ambient	(Notes 3 & 6)	$R_{\theta JA}$	2.1	$^\circ\text{C}/\text{W}$
	(Notes 3 & 7)		17.1	
	(Notes 4 & 6)		100	
Thermal Resistance, Junction to Lead	(Notes 3 & 7)	$R_{\theta JL}$	70	$^\circ\text{C}/\text{W}$
	(Notes 4 & 6)		58	
Operating and storage temperature range		$T_J, T_{STG}$	-55 to 150	$^\circ\text{C}$

- Notes:
- AEC-Q101  $V_{GS}$  maximum is  $\pm 16\text{V}$ .
  - For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
  - Same as note (3), except the device is measured at  $t \leq 10$  sec.
  - Same as note (3), except the device is pulsed with  $D = 0.02$  and pulse width 300  $\mu\text{s}$ . The pulse current is limited by the maximum junction temperature.
  - For a dual device with one active die.
  - For a device with two active die running at equal power.
  - Thermal resistance from junction to solder-point (at the end of the drain lead).

**Thermal Characteristics**

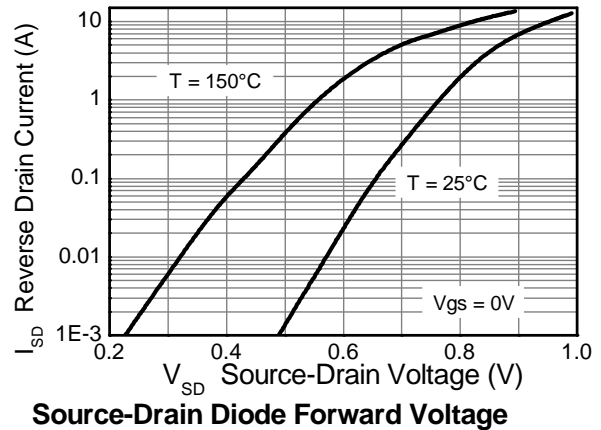
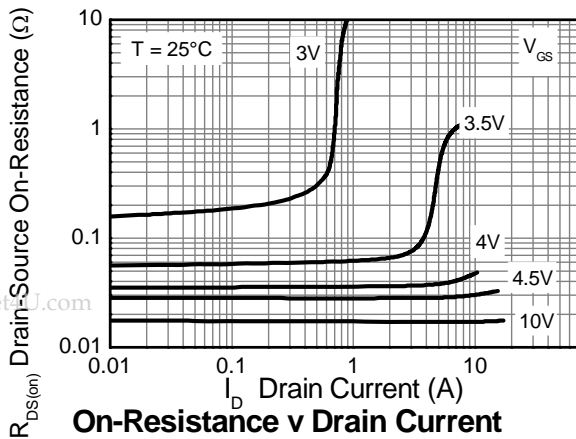
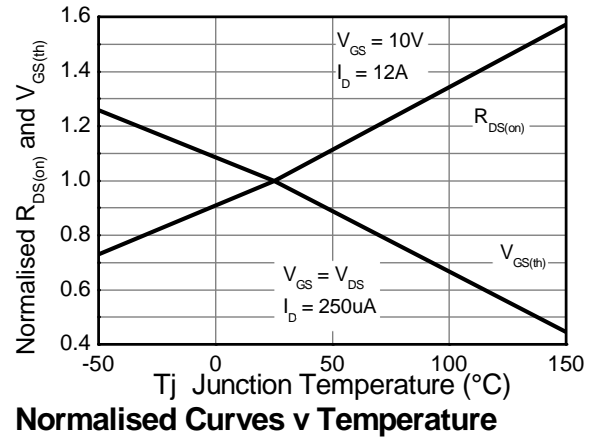
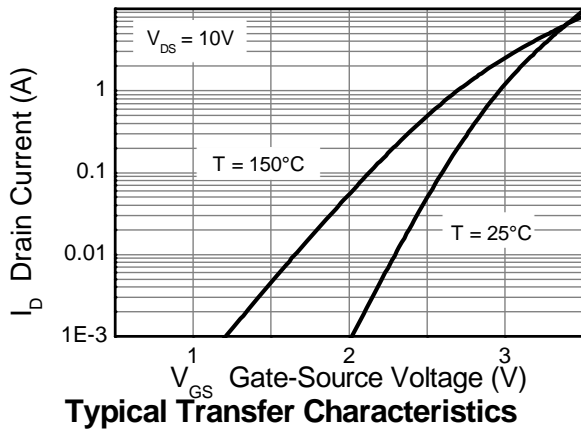
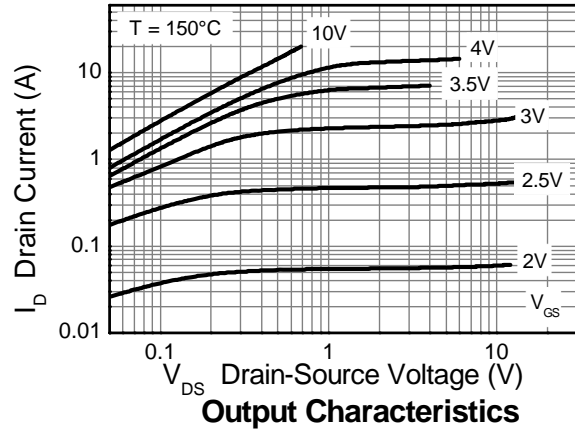
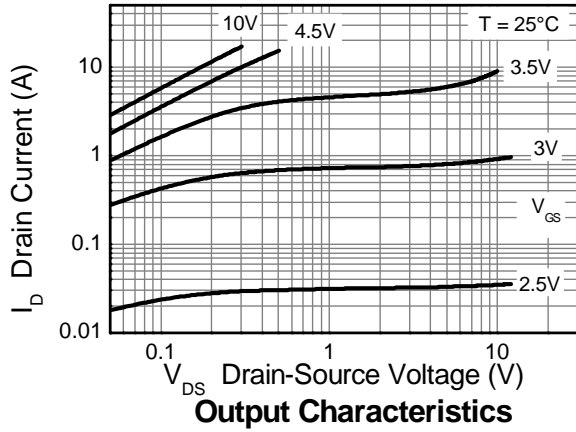


**Electrical Characteristics** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	40	—	—	V	$I_D = 250\mu\text{A}$ , $V_{GS} = 0\text{V}$
Zero Gate Voltage Drain Current	$I_{DSS}$	—	—	0.5	$\mu\text{A}$	$V_{DS} = 40\text{V}$ , $V_{GS} = 0\text{V}$
Gate-Source Leakage	$I_{GSS}$	—	—	$\pm 100$	nA	$V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(th)}$	1.0	—	3.0	V	$I_D = 250\mu\text{A}$ , $V_{DS} = V_{GS}$
Static Drain-Source On-Resistance (Note 9)	$R_{DS(on)}$	—	0.017	0.027	$\Omega$	$V_{GS} = 10\text{V}$ , $I_D = 7\text{A}$
			0.031	0.047		$V_{GS} = 4.5\text{V}$ , $I_D = 6\text{A}$
Forward Transconductance (Notes 9 & 10)	$g_{fs}$	—	22.8	—	S	$V_{DS} = 15\text{V}$ , $I_D = 7\text{A}$
Diode Forward Voltage (Note 9)	$V_{SD}$	—	0.85	1.1	V	$I_S = 7\text{A}$ , $V_{GS} = 0\text{V}$
Reverse recovery time (Note 10)	$t_{rr}$	—	12.1	—	ns	$I_S = 2.1$ , $di/dt = 100\text{A}/\mu\text{s}$
Reverse recovery charge (Note 10)	$Q_{rr}$	—	5.1	—	nC	
<b>DYNAMIC CHARACTERISTICS (Note 10)</b>						
Input Capacitance	$C_{iss}$	—	604	—	pF	$V_{DS} = 20\text{V}$ , $V_{GS} = 0\text{V}$ $f = 1\text{MHz}$
Output Capacitance	$C_{oss}$	—	106	—	pF	
Reverse Transfer Capacitance	$C_{rss}$	—	59.6	—	pF	
Total Gate Charge (Note 11)	$Q_g$	—	6.3	—	nC	$V_{GS} = 4.5\text{V}$
Total Gate Charge (Note 11)	$Q_g$	—	12.9	—	nC	$V_{GS} = 10\text{V}$
Gate-Source Charge (Note 11)	$Q_{gs}$	—	2.4	—	nC	
Gate-Drain Charge (Note 11)	$Q_{gd}$	—	3.3	—	nC	
Turn-On Delay Time (Note 11)	$t_{D(on)}$	—	3.1	—	ns	$V_{DD} = 20\text{V}$ , $V_{GS} = 10\text{V}$ $I_D = 1\text{A}$ , $R_G \cong 6.0\Omega$
Turn-On Rise Time (Note 11)	$t_r$	—	3.1	—	ns	
Turn-Off Delay Time (Note 11)	$t_{D(off)}$	—	15.4	—	ns	
Turn-Off Fall Time (Note 11)	$t_f$	—	7.5	—	ns	

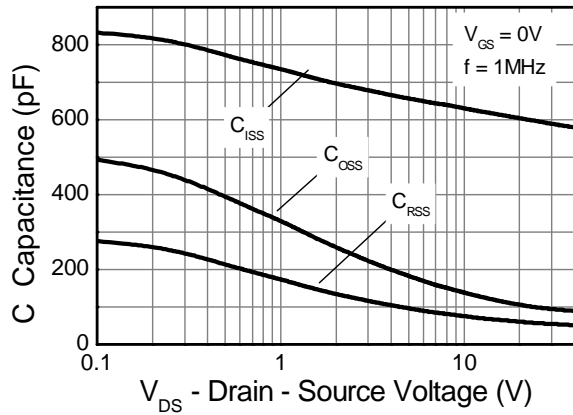
Notes: 9. Measured under pulsed conditions. Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$   
 10. For design aid only, not subject to production testing.  
 11. Switching characteristics are independent of operating junction temperatures.

**Typical Characteristics**

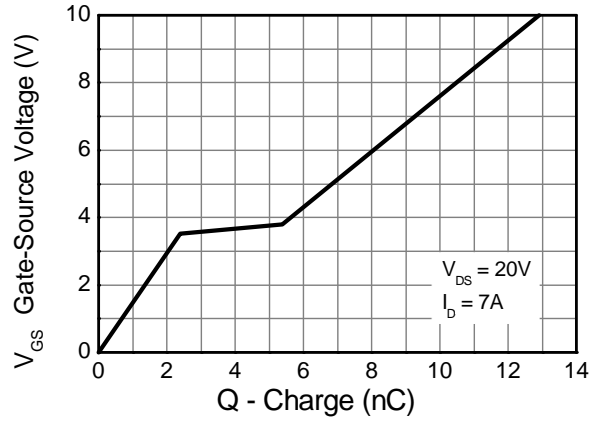


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**Typical Characteristics - continued**

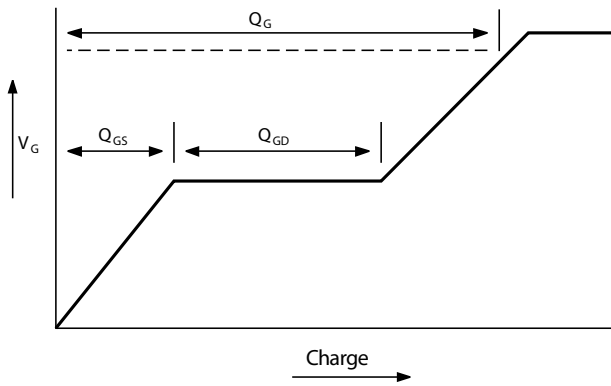


**Capacitance v Drain-Source Voltage**

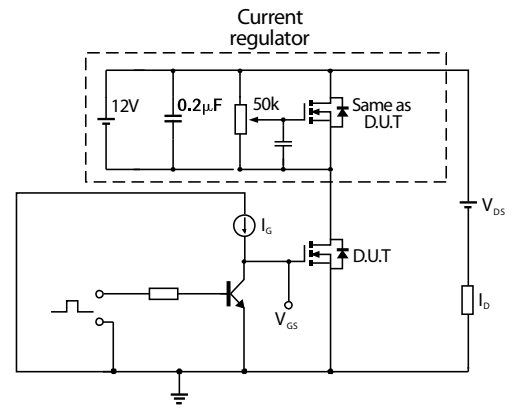


**Gate-Source Voltage v Gate Charge**

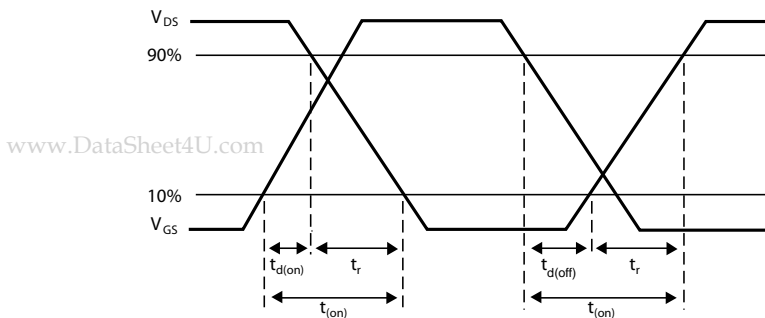
**Test Circuits**



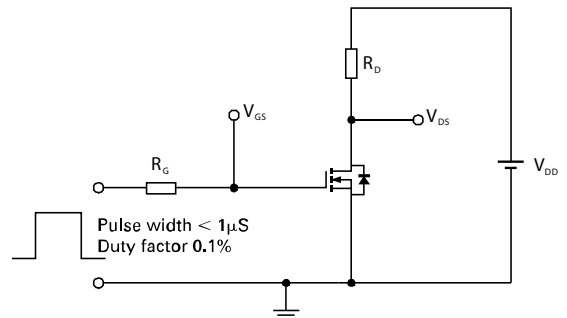
**Basic gate charge waveform**



**Gate charge test circuit**



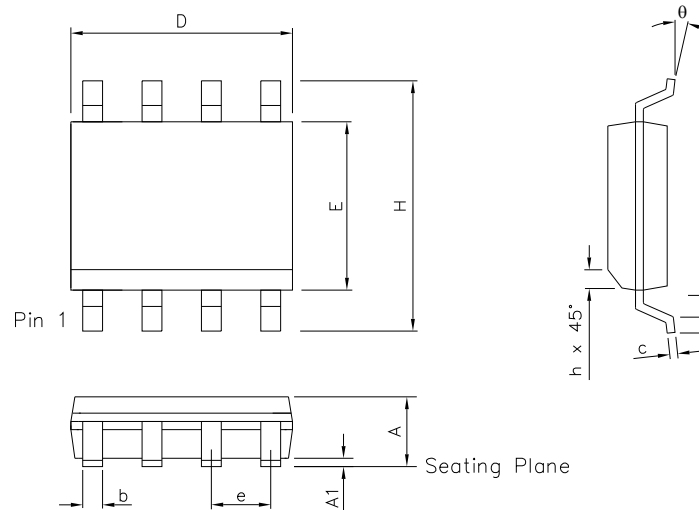
**Switching time waveforms**



**Switching time test circuit**

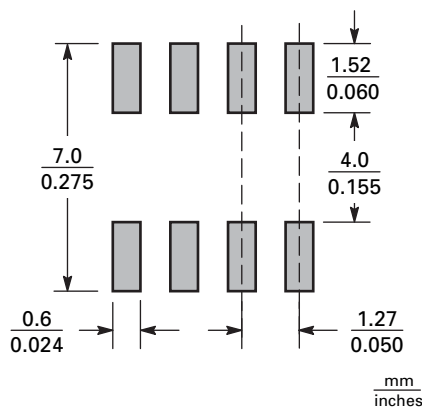
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**Package Outline Dimensions**



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.053	0.069	1.35	1.75	e	0.050 BSC		1.27 BSC	
A1	0.004	0.010	0.10	0.25	b	0.013	0.020	0.33	0.51
D	0.189	0.197	4.80	5.00	c	0.008	0.010	0.19	0.25
H	0.228	0.244	5.80	6.20	θ	0°	8°	0°	8°
E	0.150	0.157	3.80	4.00	h	0.010	0.020	0.25	0.50
L	0.016	0.050	0.40	1.27	-	-	-	-	-

**Suggested Pad Layout**



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